

N-Channel Enhancement Mode MOSFET

Feature

- 150V/130A
 R_{DS(ON)}= 11.5mΩ(typ.)@VGS = 10V
- 100% Avalanche Tested
- Reliable and Rugged
- Halogen Free and Green Devices Available (RoHS Compliant)

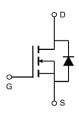
Pin Description



TO-247A-3L

Applications

- Brushless Motor Drive
- Electric Power Steering



N Channel MOSFET

Ordering and Marking Information



Package Code

W:TO-247A-3L

Date Code YYXXX WW Assembly Material G:Halogen Free

Note:HUA YI lead-free products contain molding compounds/die attach materials and 100% matte tin plateTermi-Nationfinish; which are fully compliant with RoHS.HUA YI lead-free products meet or exceed the lead-Free requirements of IPC/JEDEC J-STD-020 for MSL classification at lead-free peak reflow temperature.HUA YI defines "Green" to mean lead-free (RoHS compliant) and halogen free (Br or CI does not exceed 900ppm by weight in homogeneous material and total of Br and CI does not exceed 1500ppm by weight).

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Absolute Maximum Ratings

| Symbol | Parameter | | Rating | Unit |
|-----------------|---|----------|------------|------|
| Common Rat | tings (Tc=25°C Unless Otherwise Noted) | | | |
| Voss | Drain-Source Voltage | | 150 | V |
| Vgss | Gate-Source Voltage | | ±25 | V |
| TJ | Maximum Junction Temperature | | 175 | °C |
| Тѕтс | Storage Temperature Range | | -55 to 175 | °C |
| Is | Source Current-Continuous(Body Diode) Tc=25°C | | 130 | Α |
| Mounted on | Large Heat Sink | | | 1 |
| lрм | Pulsed Drain Current * | Tc=25°C | 510 | А |
| I_ | Continuous Drain Current | Tc=25°C | 130 | А |
| lσ | Continuous Drain Current | Tc=100°C | 93 | А |
| | Mariana Barra Biratarita | Tc=25°C | 349 | W |
| PD | P _D Maximum Power Dissipation Tc=100°C | | 174 | W |
| $R_{	heta JC}$ | Thermal Resistance-Junction to Case | | 0.43 | °C/W |
| $R_{\theta JA}$ | Thermal Resistance-Junction to Ambient ** | | 62.5 | °C/W |
| Eas | SinglePulsed-Avalanche Energy *** | L=0.5mH | 1024.8 | mJ |

Note:

- * Repetitive rating; pulse width limited by max.junction temperature.
- ** Surface Mounted on FR4 Board.
- *** Limited by TJmax , starting TJ=25°C, L = 0.5mH, VD= 100V, VGs =10V.

Electrical Characteristics(Tc =25°C Unless Otherwise Noted)

| Ols al | Bonomoton. | Took Conditions | HY3215 | | | |
|-------------------------------------|----------------------------------|---|--------|------|------|------|
| Symbol Parameter | | Test Conditions | Min | Тур. | Max | Unit |
| Static Cha | racteristics | | | | | |
| BVDSS | Drain-Source Breakdown Voltage | V _{GS} =0V,I _{DS} =250μA | 150 | - | - | V |
| Desire to Comment and a second | | V _{DS} =150,V _{GS} =0V | - | - | 1 | μA |
| loss Drain-to-Source LeakageCurrent | TJ=125°C | - | - | 50 | μA | |
| VGS(th) | Gate Threshold Voltage | V _{DS} =V _{GS} , I _{DS} =250μA | 3 | 4 | 5 | V |
| lgss | Gate-Source Leakage Current | V _{GS} =±25V,V _{DS} =0V | - | - | ±100 | nA |
| RDS(ON)* | Drain-Source On-State Resistance | V _{GS} =10V,I _{DS} =40A | - | 11.5 | 14 | mΩ |
| Diode Cha | racteristics | | | | | |
| V _{SD} * | Diode Forward Voltage | Isp=50A,Vgs=0V | - | 0.8 | 1.2 | V |
| t rr | Reverse Recovery Time | InE0A dia-/dt-100A/ug | - | 46 | - | ns |
| Qrr | Reverse Recovery Charge | IsD=50A,dIsD/dt=100A/µs | - | 98 | - | nC |

HY3215W



Electrical Characteristics (Cont.) (Tc =25°C Unless Otherwise Noted)

| Comple of | Dougnator | Took Conditions | | HY3215 | | 110024 |
|-----------|------------------------------|--|-----|--------|-----|--------|
| Symbol | Parameter | Test Conditions | Min | Тур. | Max | Unit |
| Dynamic | Characteristics | | | | | |
| Rg | Gate Resistance | V _{GS} =0V,V _{DS} =0V,F=1 MHz | - | 3.1 | - | Ω |
| Ciss | Input Capacitance | Vgs=0V, | - | 5925 | - | |
| Coss | Output Capacitance | V _{DS} =25V, | - | 480 | - | pF |
| Crss | Reverse Transfer Capacitance | Frequency=1.0MHz | - | 194 | - | |
| td(ON) | Turn-on Delay Time | | - | 30 | - | |
| Tr | Turn-on Rise Time | V_{DD} =75 V , R_{G} =3 Ω , | - | 40 | - | |
| td(OFF) | Turn-off Delay Time | Ips=50A,Vgs=10V | - | 76 | - | ns |
| Tf | Turn-off Fall Time | | - | 56 | - | |
| Gate Cha | Gate Charge Characteristics | | | | | |
| Qg | Total Gate Charge | 1/ -400\/ \/ -40\/ | - | 135 | - | |
| Qgs | Gate-Source Charge | $V_{DS} = 100V, V_{GS} = 10V,$ $I_{D} = 30A$ | - | 29 | - | nC |
| Qgd | Gate-Drain Charge | ID-30A | - | 48 | - | |

Note: *Pulse test, pulse width ≤ 300 us, duty cycle $\leq 2\%$



Typical Operating Characteristics

Figure 1: Power Dissipation

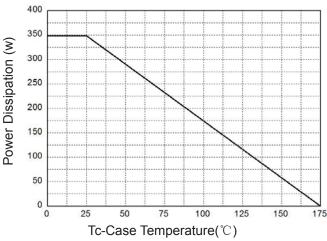


Figure 3: Safe Operation Area

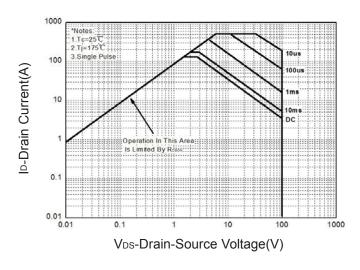


Figure 5: Output Characteristics

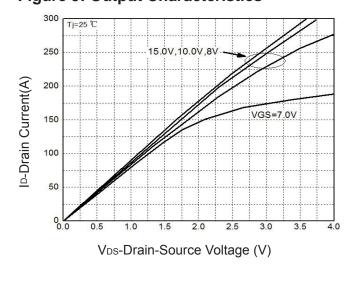


Figure 2: Drain Current

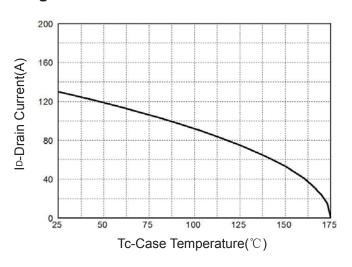


Figure 4: Thermal Transient Impedance

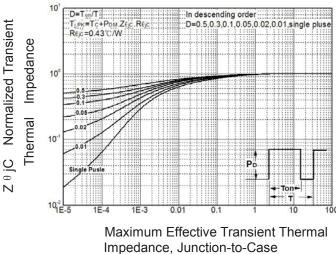
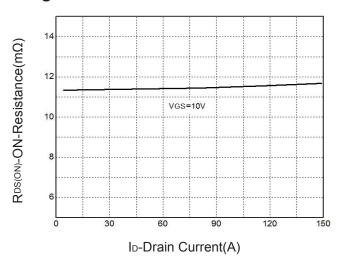


Figure 6: Drain-Source On Resistance





Typical Operating Characteristics(Cont.)

Figure 9: On-Resistance vs. Temperature

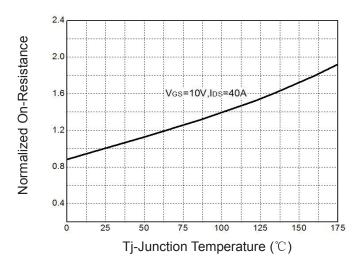


Figure 11: Capacitance Characteristics

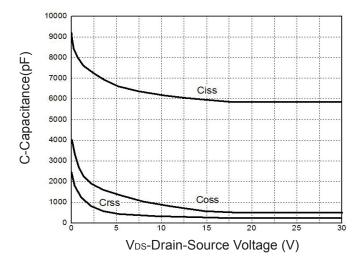


Figure 10: Source-Drain Diode Forward

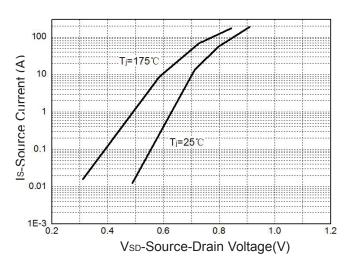
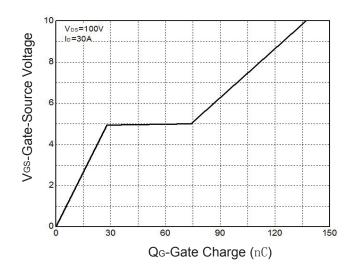
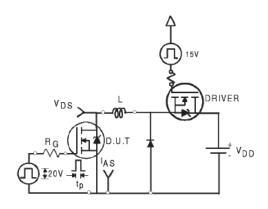


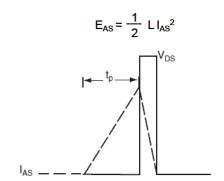
Figure 12: Gate Charge Characteristics



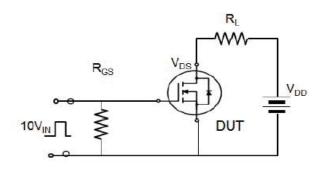


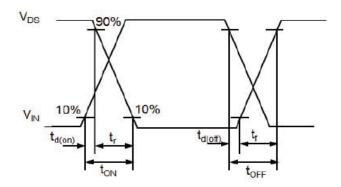
Avalanche Test Circuit



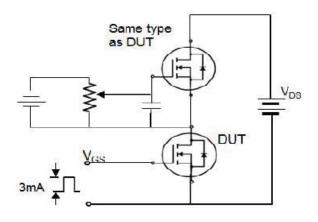


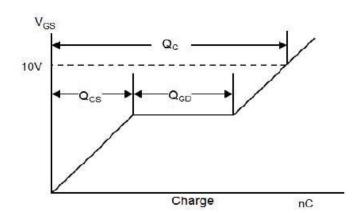
Switching Time Test Circuit





Gate Charge Test Circuit





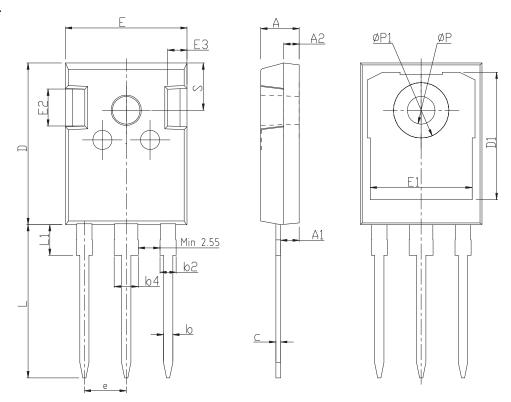


Device Per Unit

| Package Type | Unit | Quantity |
|--------------|------|----------|
| TO-247A-3L | Tube | 30 |

Package Information

TO-247A-3L

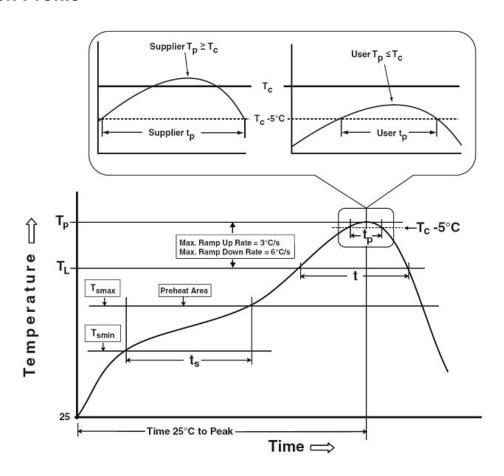


COMMON DIMENSIONS

| CAMDOI | mm | | | |
|--------|----------|-------|--------|--|
| SYMBOL | MIN | NOM | MAX | |
| A | 4.80 | 5.00 | 5. 20 | |
| A1 | 2.21 | 2.41 | 2.61 | |
| A2 | 1.85 | 2.00 | 2. 15 | |
| b | 1.11 | 1.21 | 1.36 | |
| b2 | 1.91 | 2.01 | 2. 21 | |
| b4 | 2.91 | 3.01 | 3. 21 | |
| С | 0.51 | 0.61 | 0.75 | |
| D | 20.70 | 21.00 | 21.30 | |
| D1 | 16.25 | 16.55 | 16.85 | |
| Е | 15.50 | 15.80 | 16. 10 | |
| E1 | 13.00 | 13.30 | 13.60 | |
| E2 | 4.80 | 5.00 | 5. 20 | |
| E3 | 2.30 | 2.50 | 2.70 | |
| е | 5. 44BSC | | | |
| L | 19.62 | 19.92 | 20. 22 | |
| L1 | _ | _ | 4.30 | |
| Р | 3.40 | 3.60 | 3.80 | |
| P1 | _ | _ | 7.30 | |
| S | 6. 15BSC | | | |



Classification Profile



Classification Reflow Profiles

| Profile Feature | Sn-Pb Eutectic Assembly | Pb-Free Assembly | |
|--|------------------------------------|----------------------------------|--|
| Preheat & Soak | 100 °C | 150 °C | |
| Temperature min (T _{smin}) | 150 °C | 200 °C | |
| Temperature max (T _{smax}) | 60-120 seconds | 60-120 seconds | |
| Time (Tsmin to Tsmax) (t _s) | | | |
| Average ramp-up rate | 3 °C/second max. | 3°C/second max. | |
| (T _{smax} to T _P) | | | |
| Liquidous temperature (T _L) | 183 °C | 217 °C | |
| Time at liquidous (t∟) | 60-150 seconds | 60-150 seconds | |
| Peak package body Temperature | See Classification Temp in table 1 | SeeClassification Tempin table 2 | |
| (T _p)* | Coo Glacemeation Temp in table 1 | Occordosmodion Tempin table 2 | |
| Time (t₂)** within 5°C of the specified | 20** seconds | 30** seconds | |
| classification temperature (T _c) | 20 00001140 | 30 3000103 | |
| Average ramp-down rate (Tpto Tsmax) | 6 °C/second max. | 6 °C/second max. | |
| Time 25°C to peak temperature | 6 minutes max. | 8 minutes max. | |

^{*}Tolerance for peak profile Temperature (Tp) is defined as a supplier minimum and a user maximum.

^{**} Tolerance for time at peak profile temperature (tp) is defined as a supplier minimum and a user maximum.

HY3215W



Table 1.SnPb Eutectic Process – Classification Temperatures (Tc)

| Package | Volume mm³ | Volume mm³ |
|-----------|------------|------------|
| Thickness | <350 | ≥350 |
| <2.5 mm | 235 °C | 220 °C |
| ≥2.5 mm | 220 °C | 220 °C |

Table 2.Pb-free Process – Classification Temperatures (Tc)

| Package | Volume mm³ | Volume mm³ | Volume mm³ |
|-----------------|------------|------------|------------|
| Thickness | <350 | 350-2000 | ≥2000 |
| <1.6 mm | 260 °C | 260 °C | 260 °C |
| 1.6 mm – 2.5 mm | 260 °C | 250 °C | 245 °C |
| ≥2.5 mm | 250 °C | 245 °C | 245 °C |

Reliability Test Program

| Test item | Method | Description |
|---------------|---------------|--|
| SOLDERABILITY | JESD-22, B102 | 5 Sec, 245°C |
| HTRB | JESD-22, A108 | 168 Hrs /500 Hrs /1000 Hrs, Bias @ 150°C |
| PCT | JESD-22, A102 | 96Hrs, 100%RH, 2atm, 121°C |
| TCT | JESD-22, A104 | 500 Cycles, -55°C~150°C |

Customer Service

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